
RX Family

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Rev.2.10

CTSU 3D Gesture Demo Set Sample Software

Mar 30, 2018

Introduction

This application note describes the 3D Gesture Demo Software specification using a sample application based on the Capacitive Touch Sensing Unit (CTSU), the hardware that detects human touch by measuring capacitance generated between touch electrodes and the human hand.

Target Devices

RX130, RX231

Related Documents

1. RX Family CTSU API Reference Guide (R30AN0215EJ)
2. RX Family CTSU Mutual-capacitance Touch Measurement (R30AN0217EJ)
3. RX113 Group Design Guide for Renesas Touch Solution (R30AN0218EJ)
4. RX231 Group CTSU Application Example: 3D Gesture Demo Set (Hardware) (R01AN4219EJ)
5. RX130 Group CTSU Application Example: 3D Gesture Demo Set (Hardware) (R01AN4320EJ)
6. RX Family CTSU 3D Gesture Demo Set Evaluation Tool '3D Monitor' (R20AN0501EJ)

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1. Overview

Two versions of the 3D Gesture Demo Set are available: RX231_3D Gesture Demo Set (referred to as the regular version) and RX130_3D Gesture Demo Set (referred to as the small version). For descriptions of the corresponding hardware, please refer to related documents 4 and 5 listed in the introduction.

This application note describes sample software that runs on both versions of the 3D Gesture Demo Set.

1.1 Software Structure

Figure 1.1 shows software structures for normal and small versions of the application.

The CTSU API controls the CTSU to measure electrostatic capacitance. The API was automatically generated using Workbench6, the integrated development environment for capacitance touch.

The 3D position calculation API calculates the 3D position from the results of the electrostatic capacitance measured by the CTSU API.

The gesture recognition library is used to analyze changes in the 3D position and determine gestures.

The application notifies the user of the 3D position calculation and gesture recognition results either via UART communication between the 3D Gesture Demo Set LED display and the BLE module or via USB communication with the user's PC.

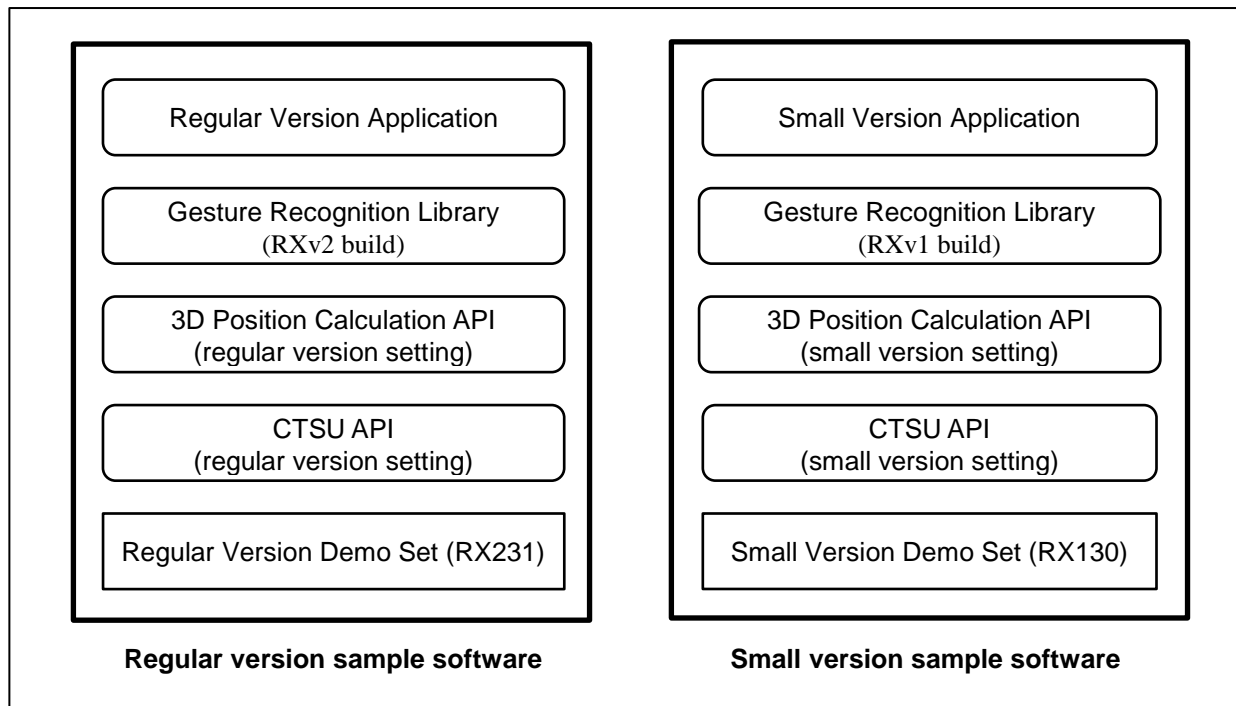


Figure 1.1 Software Structure

1.2 File Structure

Table 1.1 shows the application's file structure; the CTSU API has been left out for brevity.

Table 1.1 File Structure

Folder/File Name	Description
r_01an4101jj0210-ctsu	Project folder
TouchAPI_3DGestureRegular	Workbench6 automatically generated software
TouchApiBase.mtpj	Project file
TouchApiBase.rcpe	Common project file
Gesture_Recognition_RXv2.lib	Gesture recognition library (RXv2 build)
Source	Source folder
r_cap_position.c	3D position calculation API source file
Config_SCI12.c	SCI12 source file
Config_SCI12_user.c	SCI12 user source file
r_main.c	Application file
Include	Include folder
r_cap_position_config.h	3D position calculation API config file (regular version setting)
r_cap_position_measure.h	3D position calculation API previous measured value file (regular version setting)
r_cap_position_if.h	3D position calculation API interface file
r_cap_position.h	3D position calculation API header file
r_cap_gesture_if.h	Gesture recognition interface file
Config_SCI12.h	SCI12 header file
wbSetting	Workbench6 setting folder
TouchAPI_3DGestureSmall	Workbench6 automatically generated software
TouchApiBase.mtpj	Project file
TouchApiBase.rcpe	Common project file
Gesture_Recognition_RXv1.lib	Gesture recognition library (RXv1 build)
Source	Source folder
r_cap_position.c	3D position calculation API source file
Config_SCI1.c	SCI1 source file
Config_SCI1_user.c	SCI1 user source file
r_main.c	Application file
Include	Include folder
r_cap_position_config.h	3D position calculation API config file (small version setting)
r_cap_position_measure.h	3D position calculation API previous measured value file (small version setting)
r_cap_position_if.h	3D position calculation API interface file
r_cap_position.h	3D position calculation API header file
r_cap_gesture_if.h	Gesture recognition interface file
Config_SCI1.h	SCI1 header file
wbSetting	Workbench6 setting folder

2. Operation Confirmation Environment

2.1 Regular version

Table 2.1 lists the operating conditions of the regular version software.

Table 2.1 Operating Environment (regular version)

Item	Description
Evaluation board (in custom case)	RTK5RX2310D00000BR
MCU used	RX231
Operating frequency	54MHz
Operating voltage	3.3V
Integrated Development Environment	CS+ v6.01.00
C compiler	CC-RX v2.08.00
Capacitance touch IDE	Workbench6 V01.07.00.00

Figure 2.1 shows the connection diagram for the Gesture Demo Set.

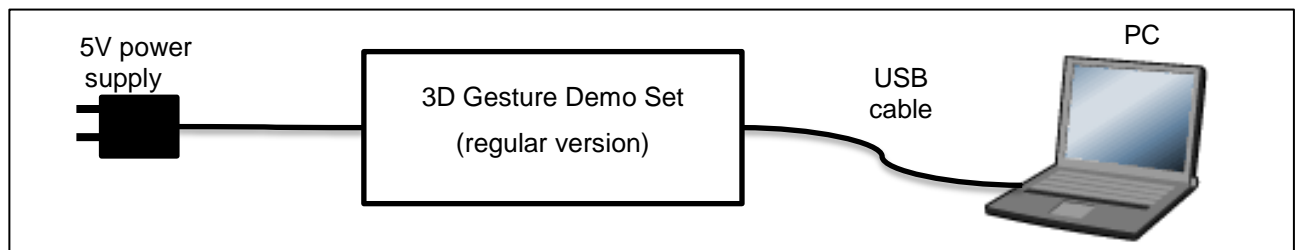


Figure 2.1 Demo Set Connection Diagram (regular version)

2.2 Small Version

Table 2.2 describes the operating environment of the small version of the software.

Table 2.2 Operating Environment (small version)

Item	Description
Evaluation board (in custom case)	RTK0EG0014D00001BJ
MCU used	RX130
Operating frequency	32MHz
Operating voltage	5.0V
Integrated Development Environment	CS+ v6.01.00
C compiler	CC-RX v2.08.00
Capacitance touch IDE	Workbench6 v01.07.00.00

Figure 2.2 shows the connection diagram for the Gesture Demo Set.

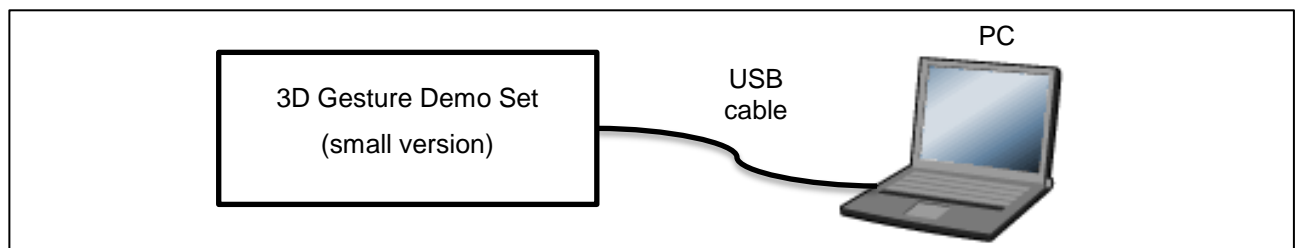


Figure 2.2 Demo Set Connection Diagram (small version)

3. CTSU API Setting

3.1 Regular Version

Set the frequency of the sensor drive pulse generated based on the CTSU base clock to 3.375 MHz. Setting the frequency to a low value will shorten the 3D position detection distance.

Edit `r_touch,h` to set the measurement cycle to 10 ms.

```
#define TOUCH_MAIN_CYCLE_US    10000
```

Edit `r_usb_pcdc_apl.c` to enable communication with the evaluation application.

Add sample application function `SampleAplReceive()` to function `usb_psmpl_MainTask()`

3.2 Small Version

Set the frequency of the sensor drive pulse generated based on the CTSU base clock to 4.000 MHz. Setting the frequency to a low value will shorten the 3D position detection distance.

Edit `r_touch,h` to set the measurement cycle to 10 ms.

```
#define TOUCH_MAIN_CYCLE_US    10000
```

Edit `r_cgc.h` to enable USB connection with the PC.

```
#define WORKBENCH_SERIAL_CONNECT    (1)
```

Edit `r_mpc.c` to enable BLE module and UART transmissions, or button-type input.

Function `initial_port_set()`

```
PORT3.PDR.BYTE = PORT3.PDR.BYTE | 0x1E;
```

```
PORT2.PDR.BYTE = 0xBF;
```

```
PORTA.PDR.BYTE = PORTA.PDR.BYTE | 0xE7;
```

Edit `r_sci.c` to enable communication with the evaluation application.

Add sample application function `SampleAplReceive()` to function `r_sci6_receive_interrupt()`.

4. 3D Position Calculation

4.1 3D Position Definition

As shown in Figure 4.1, with 0 as the origin at the center of the sensor board surface, the X axis indicates left and right directions horizontal to the board, the Y axis indicates top and bottom directions horizontal to the board, and the Z axis indicates the vertical direction from the board. The 3D position of the hand is expressed as (x, y, z). Values for x and y are integers, and z is a natural number. Positions are measured in millimeters (mm). The upper right of the board is the first quadrant ($x > 0, y > 0$), the upper left is the second quadrant ($x < 0, y > 0$), the lower left is the third quadrant ($x < 0, y < 0$), and the lower right is the fourth quadrant ($x > 0, y < 0$).

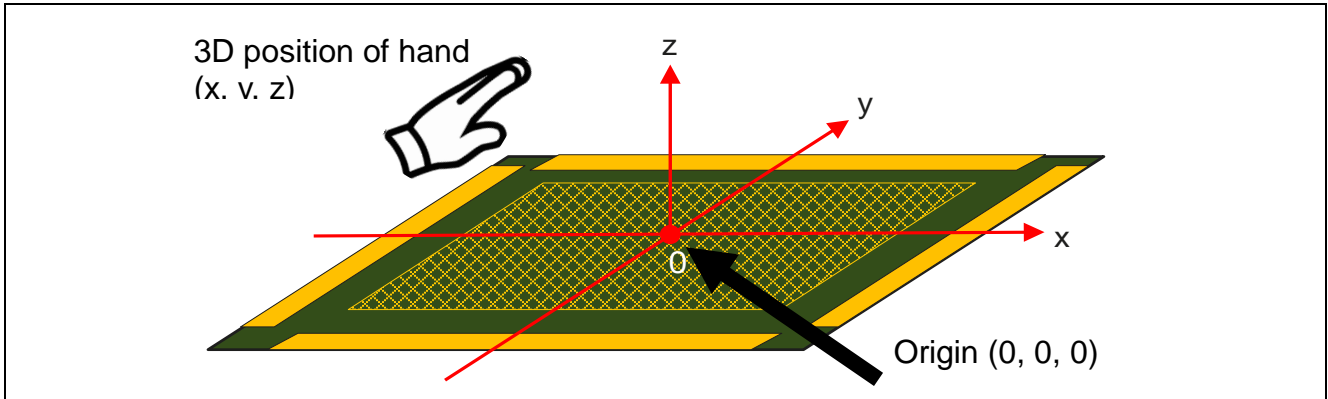


Figure 4.1 3D Position Definition

4.2 3D Position Calculation Principle

Calculation of the 3D position uses the capacitance measurement results (referred to as “count value” herein) of the top, bottom, left and right receiver electrodes (4 in total).

The reference value is the count value measured when there is nothing (hand or other conductive object) located near the evaluation board. When a hand approaches the board, the count value of the 4 receiver electrodes decrease according to the position of the hand. The 3D position of the hand is calculated from the difference between the reference value and the count value. If the count values are not decreasing, the 3D position cannot be calculated in that spot.

The relationship between this count value and the 3D position differ depending on the hardware, and values cannot be calculated using general formulas. Therefore, before developing with the sample software, it is important to first obtain a count value, or count values measured at several positions, from the hardware you are using when there is no conductive object in the vicinity.

Figure 4.2 shows the reference and count values when a hand is placed near, then removed from, the electrodes.

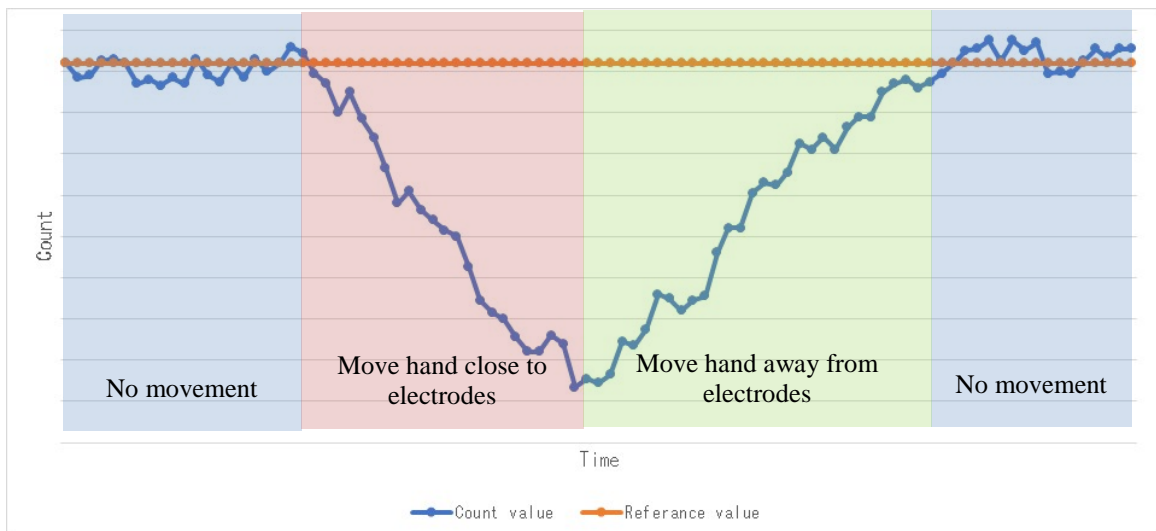


Figure 4.2 Reference Value and Count Value

4.3 3D Position Calculation Pre-Measurement Conditions

The required conditions of the positions before measurement is obtained are as follows.

[Z axis]

- Count values of 4 electrodes in 3 to 10 locations where x and y are 0
 - Calculation accuracy increases as the number of measured positions increases.
 - The farthest measurement position is the calculation range of z. We recommend obtaining at least 100 counts equaling the difference with the reference value.

[X axis]

- Count values of right and left electrodes in 1 location 30mm or more in the plus direction of the X axis from the position measured on the Z axis

[Y axis]

- Count values of top and bottom electrodes in 1 location 30mm or more in the plus direction of the Y axis from the position measured on the Z axis
 - Not required if the electrodes are vertically and horizontally symmetrical. This software does not measure in the Y axis in this case.

Please describe the measured count values in the 3D position calculation API pre-measurement file.

4.4 3D Position Calculation

4.4.1 Z position

For count value calculations, Δ_{top} represents the top electrode difference, Δ_{bottom} represents the bottom electrode, Δ_{right} represents the right electrode, and Δ_{left} represents the left electrode. The average of these differences is represented by Δ_{average} .

Calculate Δ_{average} at each Z position from the pre-measured count values, and then calculate Z position using the linear interpolation approximation formula ($\Delta_{\text{average_REF}}$).

Figure 4.3 shows $\Delta_{\text{average_REF}}$ of the evaluation board. The vertical axis is Δ_{average} and the horizontal axis is Z position.

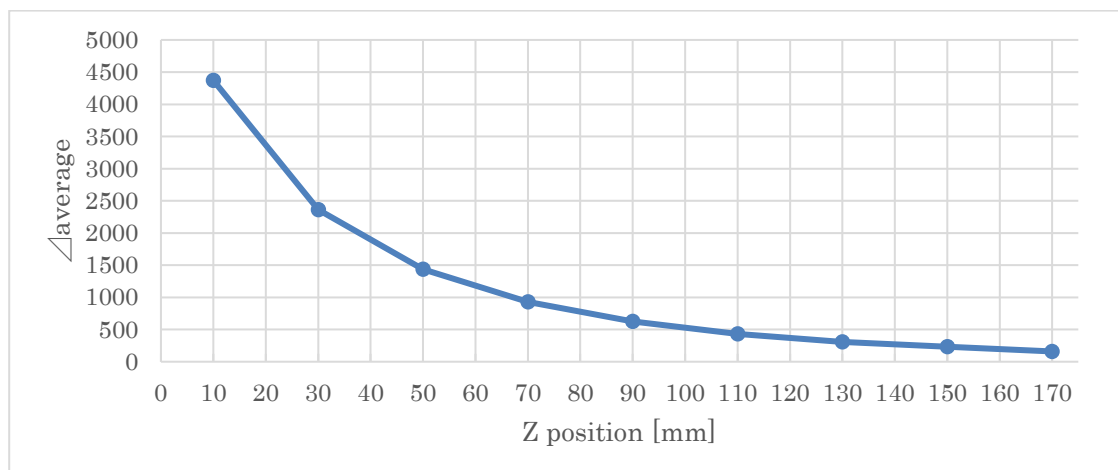


Figure 4.3 Evaluation Board $\Delta_{\text{average_REF}}$

For example, if the pre-measured value obtained is

$$\Delta_{\text{average}} = 500 \text{ at } (0, 0, 100), \text{ and } \Delta_{\text{average}} = 250 \text{ at } (0, 0, 150),$$

then when Δ_{average} is 325,

$$\begin{aligned}
 z &= 100 + ((500 - 325) / ((500 - 250) / (150 - 100))) \\
 &= 100 + (175 / 5) \\
 &= 135
 \end{aligned}$$

4.4.2 X position

The difference between Δ_{right} and Δ_{left} is $\Delta_{horizontal}$.

Although $\Delta_{horizontal}$ and X position are proportional, the slope (Δ_{x_slope}) differs depending on Z position.

Figure 4.4 shows $\Delta_{horizontal}$ of the evaluation board. The vertical axis is $\Delta_{horizontal}$ and the horizontal axis is X position.

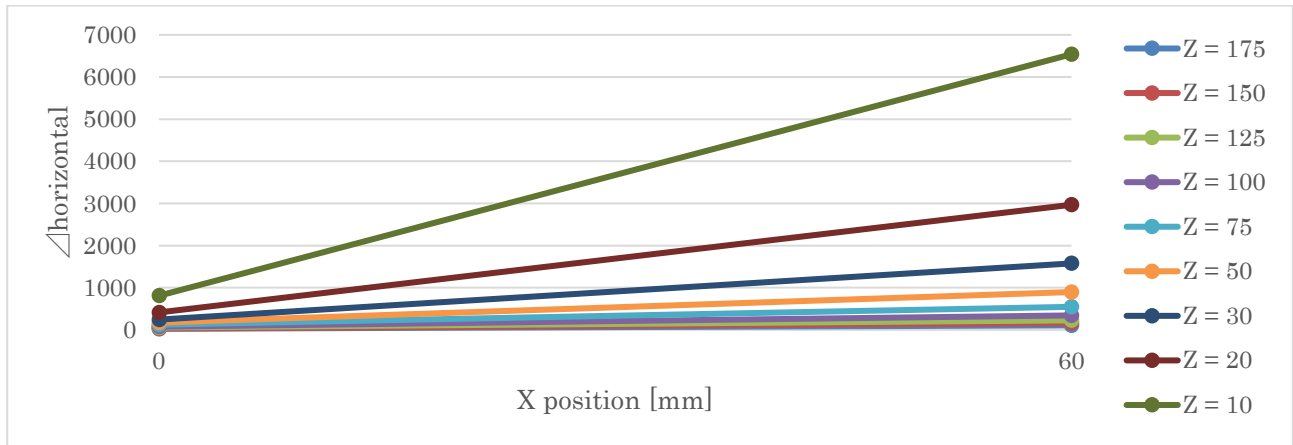


Figure 4.4 Evaluation Board $\Delta_{horizontal}$

Calculate Δ_{x_slope} at each Z position from the pre-measured count values, and then X position is calculated using the linear interpolation approximation formula ($\Delta_{x_slope_REF}$).

Figure 4.5 shows $\Delta_{x_slope_REF}$ of the evaluation board. The vertical axis is Δ_{x_slope} and the horizontal axis is Z position.

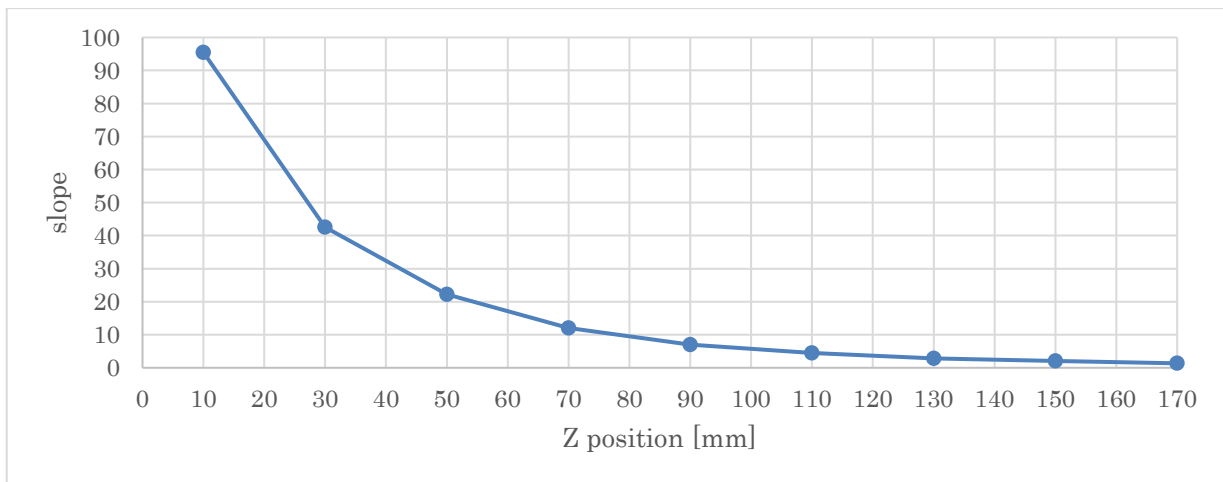


Figure 4.5 Evaluation Board $\Delta_{x_slope_REF}$

Finally, correct the sensitivity difference of left and right electrodes from $\Delta_{horizontal}$ at the pre-measured X position 0. Because $\Delta_{horizontal}$ varies according to the Z position, linear interpolation approximation formula is used in the same way. Let this correction value be $\Delta_{horizontal_offset}$.

For example, if the pre-measured values obtained are:

Z position is 100mm and $\Delta x_{\text{slope}} = 8$,

Z position is 150mm and $\Delta x_{\text{slope}} = 3$,

and Z position is calculated as 135mm,

$$\begin{aligned}\Delta x_{\text{slope}} &= 3 + ((150 - 135) * ((8 - 3) / (150 - 100))) \\ &= 3 + (15 * (5 / 50)) \\ &= 3 + 1.5 \\ &= 4.5\end{aligned}$$

And, when $\Delta \text{horizontal}$ is 180 and $\Delta \text{horizontal_offset}$ is 18 when Z position is 135mm,

$$x = (180 - 18) / 4.5 = 36$$

4.4.3 Y position

The difference between Δtop and Δbottom is $\Delta \text{vertical}$.

The calculation method for y is the same as that of x.

4.5 Moving Average Filter

The moving average filter is processed according to the obtained count values to enhance noise immunity.

The filter averages the count values up to the number of times before the moving average setting value.

The calculations described in sections 4.4 and 4.6 use the average values obtained with the moving average filter applied.

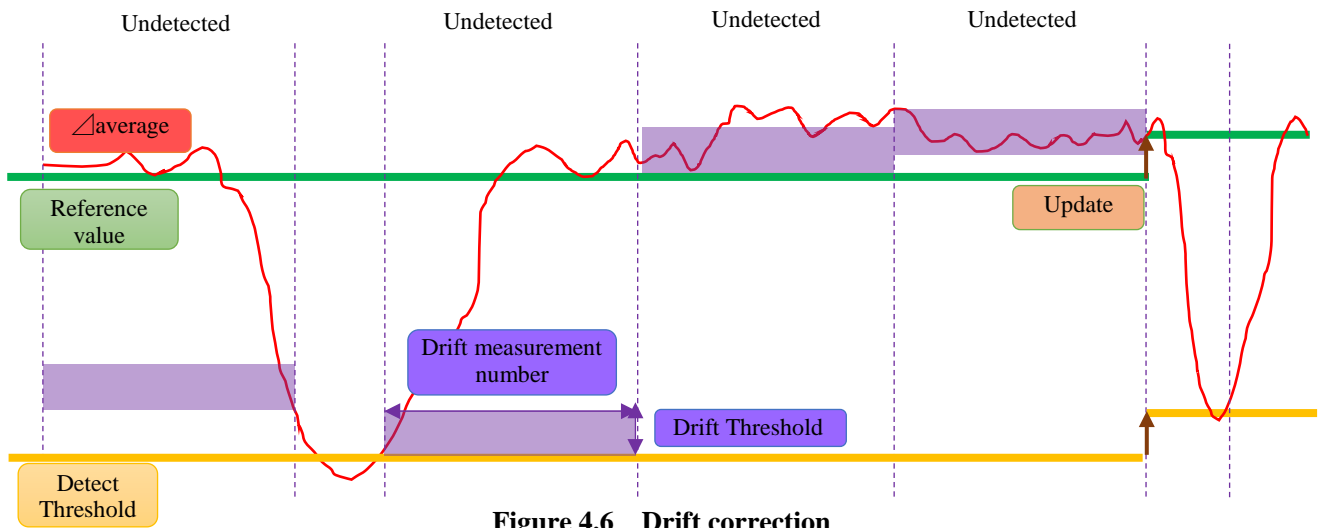
Describe the moving average setting value in the config file of the 3D position calculation API. The higher the value, the better the noise immunity, but the slower the response time.

4.6 Drift Correction

Drift correction is a process of updating the reference value so as to follow the change of the surrounding environment when judging non-detection.

When the noncontiguous determination continues for the number of drift measurements, if the difference between the maximum and minimum values of $\Delta \text{average}$ is within the drift threshold value, the reference value is updated to the current count value (moving average filter applied).

The user should describe the drift measurement number and the drift threshold in the config file of the 3D position calculation API. As the number of drift measurements is decreased and the drift threshold value is increased, the ability to adjust to changes in the surrounding environment improves. However, if drift correction is performed even when the hand is moving slowly, the result of 3D position calculation may be affected.



4.7 Noise Environment Judgement

3D position calculation is realized by capturing very minute changes in count values. In addition to the various noise immunity measures built into the CTSU, software-based noise filters are also implemented in the CTSU API, but it is currently difficult to completely remove noise.

Therefore, if the software determines that the noise level will greatly affect 3D position calculation, it stops the calculation. The high noise environment continues to be judged until a normal environment recovery is confirmed.

4.7.1 High noise environment detection judgement

When the count value meets one of the following two conditions, a high noise environment is detected. This judgement is conducted separately for each count value obtained from the 4 electrodes.

1. (Count value - reference value) is A or more
2. (Count value - previous count value) & (previous count value - 2nd preceding count value) & (2nd preceding count value - 3rd preceding count value) is (B or higher) & (-1 or lower) & (B or higher).
3. (Count value - previous count value) & (previous count value - 2nd preceding count value) & (2nd preceding count value - 3rd preceding count value) is (B or lower) & (1 or higher) & (B or lower).

A: Noise threshold value A B: Noise threshold value B

Figure 4.7 shows figures describing the conditions of the high noise environment detection judgement process.

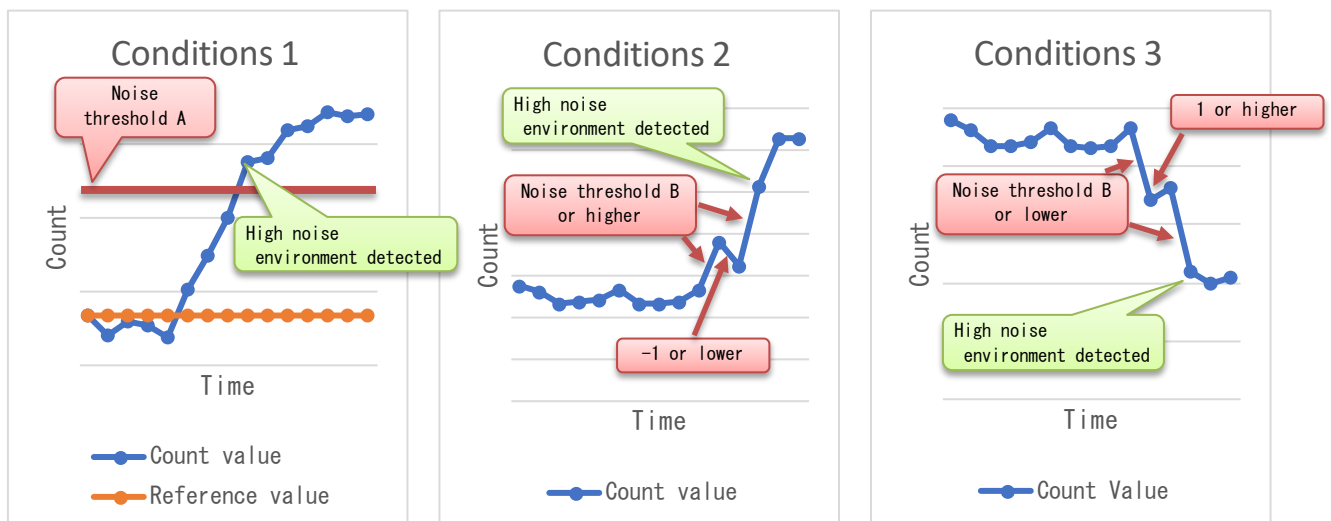


Figure 4.7 High Noise Environment Detection Judgement

Please describe noise threshold A and noise threshold B in the 3D position calculation API configuration file. The smaller the value, the more effective in detecting a high noise environment. However, this also increases the possibility of erroneously determining a normal environment as a high noise environment.

4.7.2 Normal environment recovery judgement

A “normal environment recovery” is judged when the following conditions are met.

When the average count value of four electrodes for the past N times shows the difference between the maximum and minimum values as M or less. If the value at this time is larger than the average reference value of 4 electrodes, update the reference value.

N: recovery measurement times M: recovery threshold

This judgment is carried out every time a count value is obtained after saving the count value for N times after a high noise environment is detected.

Figure 4.8 shows figures describing the judgement process of normal environment recovery.

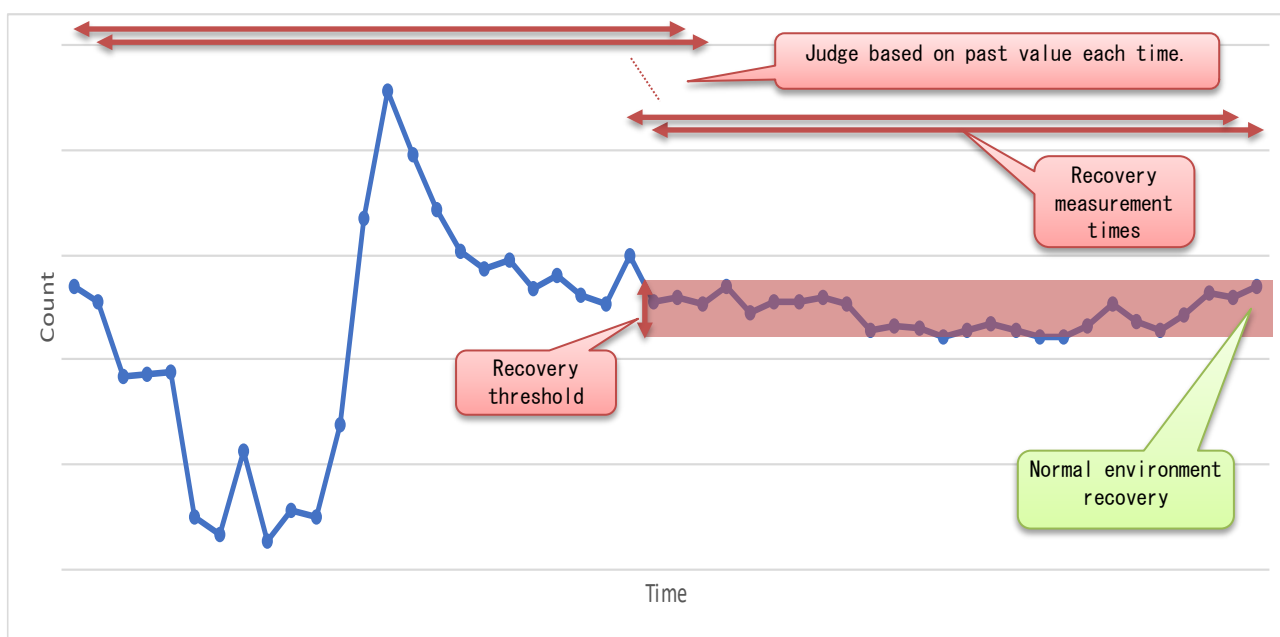


Figure 4.8 Judgement of Normal Environment Recovery

Describe the recovery measurement times and recovery threshold in the 3D position calculation API configuration file. As the number of recovery measurements decreases and the recovery threshold increases, the normal environment recovery will be faster, the possibility of erroneously determining a recovery within a high noise environment increases.

5. 3D Position Calculation Software Specification

5.1 File Configuration

Table 5.1 shows the source file used in this sample software.

Table 5.1 Source File

File Name	Description	Notes
r_cap_position.c	3D position calculation API source file	-

Table 5.2 shows the header files.

Table 5.2 Header Files

File Name	Description	Notes
r_cap_position_config.h	3D position calculation API config file	-
r_cap_position_measure.h	3D position calculation API pre-measurement file	-
r_cap_position_if.h	3D position calculation API interface file	-
r_cap_position.h	3D position calculation API header file	For use in 3D position calculation API

5.2 Constants

Table 5.3 shows the r_cap_position_if.h constants.

Table 5.3 Constants (r_cap_position_if.h)

Constant Name	Setting Value	Description
CAPPOS_NODETECT	(0x3FFF)	Value displayed when no 3D position calculation results are detected
CAPPOS_SUCCESS	(0x00)	3D position calculation API completed normally
CAPPOS_ERROR	(0x01)	3D position calculation API error occurred
CAPPOS_NORMAL	(0x00)	Value displayed when result of noise environment is normal
CAPPOS_NOISY	(0x01)	Value displayed when result of noise environment is noise detection

Table 5.4 shows the r_cap_position_config.h constants.

The default setting value is the value of the evaluation board; change as necessary to fit the usage environment.

Table 5.4 Constants (r_cap_position_config.h)

Constant Name	Setting Value (Regular)	Setting Value (Small)	Description
CAPPOS_CNF_MOVAVG_NUM	(15)	(15)	Moving average setting value
CAPPOS_CNF_DRIFT_NUM	(150)	(150)	Drift measurement number
CAPPOS_CNF_DRIFT_THR	(25)	(25)	Drift threshold
CAPPOS_CNF_RESUME_NUM	(25)	(25)	resume measurement number
CAPPOS_CNF_RESUME_THR	(20)	(20)	Resume threshold
CAPPOS_CNF_NOISE_THR_A	(150)	(150)	Noise threshold A (difference with reference value)
CAPPOS_CNF_NOISE_THR_B	(50)	(50)	Noise threshold B (difference with past value)
CAPPOS_CNF_MAX_X	(100)	(100)	X direction calculation range [mm]
CAPPOS_CNF_MAX_Y	(100)	(100)	Y direction calculation range [mm]

Table 5.5 shows the `r_cap_position_measure.h` constants.

The default setting value is the value of the evaluation board; change as necessary to fit the usage environment.

Table 5.5 Constants (`r_cap_position_measure.h`)

Constant Name	Setting Value (Regular)	Setting Value (Small)	Description
CAPPOS_MEAS_Z0	(10)	(10)	Measured Z direction position [mm] Set to 1 or higher.
CAPPOS_MEAS_Z1	(30)	(20)	Measured Z direction position [mm] Set to a value higher than CAPPOS_MEAS_Z0
CAPPOS_MEAS_Z2	(50)	(30)	Measured Z direction position [mm] Set to a value higher than CAPPOS_MEAS_Z1
CAPPOS_MEAS_Z3	(70)	(40)	Measured Z direction position [mm]. Set to a value higher than CAPPOS_MEAS_Z2. If positions were measured in 3 locations, set to 0 for this constant and all "CAPPOS_MEAS_*_3" constants.
CAPPOS_MEAS_Z4	(90)	(50)	Measured Z direction position [mm]. Set to a value higher than CAPPOS_MEAS_Z3. If positions were measured in 4 locations, set to 0 for this constant and all "CAPPOS_MEAS_*_4" constants.
CAPPOS_MEAS_Z5	(110)	(60)	Measured Z direction position [mm]. Set to a value higher than CAPPOS_MEAS_Z4. If positions were measured in 5 locations, set to 0 for this constant and all "CAPPOS_MEAS_*_5" constants.
CAPPOS_MEAS_Z6	(130)	(70)	Measured Z direction position [mm]. Set to a value higher than CAPPOS_MEAS_Z5. If positions were measured in 6 locations, set to 0 for this constant and all "CAPPOS_MEAS_*_6" constants.
CAPPOS_MEAS_Z7	(150)	(80)	Measured Z direction position [mm]. Set to a value higher than CAPPOS_MEAS_Z6. If positions were measured in 7 locations, set to 0 for this constant and all "CAPPOS_MEAS_*_7" constants.
CAPPOS_MEAS_Z8	(170)	(90)	Measured Z direction position [mm]. Set to a value higher than CAPPOS_MEAS_Z7. If positions were measured in 8 locations, set to 0 for this constant and all "CAPPOS_MEAS_*_8" constants.
CAPPOS_MEAS_Z9	(0)	(100)	Measured Z direction position [mm]. Set to a value higher than CAPPOS_MEAS_Z8. If positions were measured in 9 locations, set to 0 for this constant and all "CAPPOS_MEAS_*_9" constants.
CAPPOS_MEAS_X	(60)	(60)	Measured X direction position [mm] If the X direction is not measured, set to 0 for this constant.
CAPPOS_MEAS_Y	(0)	(0)	Measured Y direction position [mm] If the Y direction is not measured, set to 0 for this constant.
CAPPOS_MEAS_TOP	(44637)	(37390)	Top electrode count value when nothing is in vicinity of board
CAPPOS_MEAS_BTM	(40961)	(38310)	Bottom electrode count value when nothing is in vicinity of board
CAPPOS_MEAS_RGT	(40249)	(37725)	Right electrode count value when nothing is in vicinity of board
CAPPOS_MEAS_LFT	(37431)	(40357)	Left electrode count value when nothing is in vicinity of board
CAPPOS_MEAS_TOP0	(40782)	(33307)	Top electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z0)
CAPPOS_MEAS_TOP1	(42607)	(35353)	Top electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z1)
CAPPOS_MEAS_TOP2	(43417)	(36185)	Top electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z2)
CAPPOS_MEAS_TOP3	(43844)	(36614)	Top electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z3)

CAPPOS_MEAS_TOP4	(44108)	(36842)	Top electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z4)
CAPPOS_MEAS_TOP5	(44272)	(36982)	Top electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z5)
CAPPOS_MEAS_TOP6	(44373)	(37100)	Top electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z6)
CAPPOS_MEAS_TOP7	(44432)	(37199)	Top electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z7)
CAPPOS_MEAS_TOP8	(44505)	(37221)	Top electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z8)
CAPPOS_MEAS_TOP9	(0)	(37279)	Top electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z9)
CAPPOS_MEAS_BTM0	(35517)	(34539)	Bottom electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z0)
CAPPOS_MEAS_BTM1	(38022)	(36341)	Bottom electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z1)
CAPPOS_MEAS_BTM2	(39181)	(37075)	Bottom electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z2)
CAPPOS_MEAS_BTM3	(39823)	(37490)	Bottom electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z3)
CAPPOS_MEAS_BTM4	(40202)	(37721)	Bottom electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z4)
CAPPOS_MEAS_BTM5	(40440)	(37860)	Bottom electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z5)
CAPPOS_MEAS_BTM6	(40589)	(37975)	Bottom electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z6)
CAPPOS_MEAS_BTM7	(40679)	(38061)	Bottom electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z7)
CAPPOS_MEAS_BTM8	(40769)	(38127)	Bottom electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z8)
CAPPOS_MEAS_BTM9	(0)	(38197)	Bottom electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z9)
CAPPOS_MEAS_RGT0	(35751)	(33743)	Right electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z0)
CAPPOS_MEAS_RGT1	(37803)	(35698)	Right electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z1)
CAPPOS_MEAS_RGT2	(38757)	(36484)	Right electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z2)
CAPPOS_MEAS_RGT3	(39273)	(36901)	Right electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z3)
CAPPOS_MEAS_RGT4	(39580)	(37139)	Right electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z4)
CAPPOS_MEAS_RGT5	(39791)	(37288)	Right electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z5)
CAPPOS_MEAS_RGT6	(39922)	(37407)	Right electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z6)
CAPPOS_MEAS_RGT7	(40009)	(37495)	Right electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z7)
CAPPOS_MEAS_RGT8	(40079)	(37534)	Right electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z8)
CAPPOS_MEAS_RGT9	(0)	(37597)	Right electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z9)
CAPPOS_MEAS_LFT0	(33743)	(36378)	Left electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z0)
CAPPOS_MEAS_LFT1	(35399)	(38354)	Left electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z1)
CAPPOS_MEAS_LFT2	(36183)	(39150)	Left electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z2)
CAPPOS_MEAS_LFT3	(36628)	(39562)	Left electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z3)
CAPPOS_MEAS_LFT4	(36886)	(39802)	Left electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z4)
CAPPOS_MEAS_LFT5	(37048)	(39938)	Left electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z5)
CAPPOS_MEAS_LFT6	(37161)	(40047)	Left electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z6)
CAPPOS_MEAS_LFT7	(37222)	(40110)	Left electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z7)
CAPPOS_MEAS_LFT8	(37286)	(40176)	Left electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z8)
CAPPOS_MEAS_LFT9	(0)	(40248)	Left electrode count value measured when coordinates are (0, 0, CAPPOS_MEAS_Z9)
CAPPOS_MEAS_X_RGT0	(32791)	(34470)	Right electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z0)
CAPPOS_MEAS_X_RGT1	(36733)	(35920)	Right electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z1)
CAPPOS_MEAS_X_RGT2	(38231)	(36622)	Right electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z2)
CAPPOS_MEAS_X_RGT3	(38998)	(36998)	Right electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z3)
CAPPOS_MEAS_X_RGT4	(39423)	(37212)	Right electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z4)
CAPPOS_MEAS_X_RGT5	(39704)	(37340)	Right electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z5)
CAPPOS_MEAS_X_RGT6	(39868)	(37453)	Right electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z6)
CAPPOS_MEAS_X_RGT7	(39971)	(37513)	Right electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z7)
CAPPOS_MEAS_X_RGT8	(40062)	(37591)	Right electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z8)
CAPPOS_MEAS_X_RGT9	(0)	(37616)	Right electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z9)
CAPPOS_MEAS_X_LFT0	(36513)	(39557)	Left electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z0)
CAPPOS_MEAS_X_LFT1	(36884)	(39824)	Left electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z1)
CAPPOS_MEAS_X_LFT2	(36990)	(39943)	Left electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z2)
CAPPOS_MEAS_X_LFT3	(37078)	(40033)	Left electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z3)
CAPPOS_MEAS_X_LFT4	(37152)	(40108)	Left electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z4)
CAPPOS_MEAS_X_LFT5	(37229)	(40149)	Left electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z5)

CAPPOS_MEAS_X_LFT6	(37275)	(40211)	Left electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z6)
CAPPOS_MEAS_X_LFT7	(37310)	(40216)	Left electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z7)
CAPPOS_MEAS_X_LFT8	(37350)	(40284)	Left electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z8)
CAPPOS_MEAS_X_LFT9	(0)	(40299)	Left electrode count value measured when coordinates are (CAPPOS_MEAS_X, 0, CAPPOS_MEAS_Z9)
CAPPOS_MEAS_Y_TOP0	(0)	(0)	Top electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z0)
CAPPOS_MEAS_Y_TOP1	(0)	(0)	Top electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z1)
CAPPOS_MEAS_Y_TOP2	(0)	(0)	Top electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z2)
CAPPOS_MEAS_Y_TOP3	(0)	(0)	Top electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z3)
CAPPOS_MEAS_Y_TOP4	(0)	(0)	Top electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z4)
CAPPOS_MEAS_Y_TOP5	(0)	(0)	Top electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z5)
CAPPOS_MEAS_Y_TOP6	(0)	(0)	Top electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z6)
CAPPOS_MEAS_Y_TOP7	(0)	(0)	Top electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z7)
CAPPOS_MEAS_Y_TOP8	(0)	(0)	Top electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z8)
CAPPOS_MEAS_Y_TOP9	(0)	(0)	Top electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z9)
CAPPOS_MEAS_Y_BTM0	(0)	(0)	Bottom electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z0)
CAPPOS_MEAS_Y_BTM1	(0)	(0)	Bottom electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z1)
CAPPOS_MEAS_Y_BTM2	(0)	(0)	Bottom electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z2)
CAPPOS_MEAS_Y_BTM3	(0)	(0)	Bottom electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z3)
CAPPOS_MEAS_Y_BTM4	(0)	(0)	Bottom electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z4)
CAPPOS_MEAS_Y_BTM5	(0)	(0)	Bottom electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z5)
CAPPOS_MEAS_Y_BTM6	(0)	(0)	Bottom electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z6)
CAPPOS_MEAS_Y_BTM7	(0)	(0)	Bottom electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z7)
CAPPOS_MEAS_Y_BTM8	(0)	(0)	Bottom electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z8)
CAPPOS_MEAS_Y_BTM9	(0)	(0)	Bottom electrode count value measured when coordinates are (0, CAPPOS_MEAS_Y, CAPPOS_MEAS_Z9)

5.3 Structures

Table 5.6 shows the `st_position_result_t` structures.

Table 5.6 `st_cappos_result_t` Structures

Type	Member	Description
<code>int16_t</code>	<code>coord_x</code>	x position calculation result [mm]
<code>int16_t</code>	<code>coord_y</code>	y position calculation result [mm]
<code>int16_t</code>	<code>coord_z</code>	z position calculation result [mm]
<code>uint8_t</code>	<code>noise</code>	Result of noise environment detection

Table 5.7 shows the `st_captouch_data_t` structures.

Table 5.7 `st_captouch_data_t` Structures

Type	Member	Description
<code>uint16_t</code>	<code>top</code>	Top electrode count value
<code>uint16_t</code>	<code>btm</code>	Bottom electrode count value
<code>uint16_t</code>	<code>rgt</code>	Right electrode count value
<code>uint16_t</code>	<code>lft</code>	Left electrode count value

5.4 API Function Specifications

5.4.1 R_CAPPOS_Create

Initialization API

Format

uint8_t R_CAPPOS_Create(void)

Argument

Note

Return Value

CAPPOS_SUCCESS	Successful completion
CAPPOS_ERROR	Abnormal completion

Description

This API initializes the 3D position calculation API variables and creates the 3D position calculation coefficients from the 3D position calculation API config file. If there is a problem in the 3D position calculation API config file, the function returns CAPPOS_ERROR.

Remarks

This function is called only once immediately after system startup.

5.4.2 R_CAPPOS_GetAve

Get moving average value API

Format

uint8_t R_CAPPOS_GetAve(st_captouch_data_t * p_captouch_data)

Argument

*p_captouch_data 4 electrode counter value data pointer

Return Value

CAPPOS_SUCCESS Successful completion

CAPPOS_ERROR Abnormal completion

Description

This API stores the moving average value of the four electrodes stored by the 3D position calculation API in the argument *p_captouch_data.

When the argument is NULL, the function returns CAPPOS_ERROR.

5.4.3 R_CAPPOS_GetRef

Get reference value API

Format

uint8_t R_CAPPOS_GetRef(st_captouch_data_t * p_captouch_data)

Argument

*p_captouch_data 4 electrode counter value data pointer

Return Value

CAPPOS_SUCCESS Successful completion
CAPPOS_ERROR Abnormal completion

Description

This API stores the reference value of the four electrodes stored by the 3D position calculation API in the argument *p_captouch_data.

When the argument is NULL, the function returns CAPPOS_ERROR.

5.4.4 R_CAPPOS_Read

3D Position Calculation API

Format

```
uint8_t R_CAPPOS_Read(st_cappos_result_t * p_cappos_result, const st_captouch_data_t * p_captouch_data)
```

Argument

*p_cappos_result	3D position calculation result pointer
*p_captouch_data	4 electrode counter value data pointer

Return Value

CAPPOS_SUCCESS	Successful completion
CAPPOS_ERROR	Abnormal completion

Description

This API stores the results of the 3D position calculated from the value of the 4-electrode count of argument *p_captouch_data in argument *p_cappos_result.

When high noise environment, CAPPOS_NOISY is stored in argument *p_cappos_result.

When the argument is NULL, or when R_CAPPOS_Create() is not called before the API call, the function returns CAPPOS_ERROR.

Remarks

If the API is not called the number of times indicated by the moving average setting value (CAPPOS_CNF_MOVAVG_NUM), CAPPOS_NODETECT is stored in argument *p_cappos_result.

Call this API after confirming that return value of R_Set_Cap_Touch_Result_Create() is 0_SUCCESS in the CTSU API's electrostatic capacitance measurement period.

Calling this API periodically also automatically implements the moving average filter (refer to 4.5), the drift correction (refer to 4.6), and the high noise environment judgement (refer to 4.7).

6. Gesture Recognition Library Specification

6.1 File Configuration

Table 6.1 shows the library files.

Table 6.1 Library Files

File Name	Description	Notes
Gesture_Recognition_RXv2.lib	Gesture recognition library file (RXv2 build)	For regular version
Gesture_Recognition_RXv1.lib	Gesture recognition library file (RXv1 build)	For small version

Table 6.2 shows the header file.

Table 6.2 Header File

File Name	Description	Notes
r_cap_gesture_if.h	Gesture recognition API interface file	-

6.2 Constants

Table 6.3 shows the constants. These are defined by enumerated type `e_gesture_result_t`.

Table 6.3 Constants

Constant Name	Setting Value	Description
GESTURE_RESULT_NONE	(0)	No recognition
GESTURE_RESULT_RIGHT_SWIPE	(1)	Right swipe
GESTURE_RESULT_LEFT_SWIPE	(2)	Left swipe
GESTURE_RESULT_FRONT_SWIPE	(3)	Front swipe
GESTURE_RESULT_BACK_SWIPE	(4)	Back swipe
GESTURE_RESULT_DOWN_SWIPE	(5)	Push
GESTURE_RESULT_CW_SLOW	(6)	Draw circle (Clockwise, Slow)
GESTURE_RESULT_CW_FAST	(7)	Draw circle (Clockwise, Fast)
GESTURE_RESULT_RESERVE	(8)	Reserved
GESTURE_RESULT_CCW_SLOW	(9)	Draw circle (Counter clockwise, Slow)
GESTURE_RESULT_CCW_FAST	(10)	Draw circle (Counter clockwise, Fast)
GESTURE_RESULT_RESERVE2	(11)	Reserved2

6.3 Structures

Table 6.4 shows the `st_cappos_input_t` structure.

Table 6.4 st_cappos_input_t Structures

Type	Member	Description
int16_t	coord_x	x position calculation result [mm]
int16_t	coord_y	y position calculation result [mm]
int16_t	coord_z	z position calculation result [mm]
uint8_t	noise	Result of noise environment detection

6.4 API Function Specifications

6.4.1 R_GESTURE_Detect

Gesture Recognition API

形式

```
uint16_t R_GESTURE_Detect(e_gesture_result_t * p_result, const st_cappos_input_t * p_cappos_input)
```

引数

e_gesture_result_t	*p_result	Gesture recognition result pointer
st_cappos_input_t	*p_cappos_input	3D Position Calculation input pointer

戻り値

0	Successful completion
---	-----------------------

解説

This API stores the result of gesture recognition processing in p_result with the 3D position calculation result as input.

7. Sample Application

The 3D Gesture sample application has been added based on the CTSU API application file `r_main.c`.

- Demo Set initialization

Initialization function `SampleInitialize()` has been added before the main function loop.

- Results notification

Function `SampleApplication()`, which notifies the user of the 3D position calculation and gesture recognition results after return value `_0_SUCCESS` has been confirmed in `R_Set_Cap_Touch_Result_Create ()` of the main function loop.

Based on this, `SampleApplication()` is called for each touch measurement cycle.

- LED display

Table 7.1 shows the display for each LED.

Table 7.1 LED Display

Regular ver. LED	Small ver. LED	ON	OFF
LED1 (green)	D10 (orange)	Initialization complete	Initialization incomplete
LED2 (orange)	D9 (green)	3D position calculation results detected	3D position calculation results not detected
LED3 (green)	D8 (orange)	Noise environment detected	Normal environment
LED4 (orange)	D7 (green)	Communicating with evaluation app	Not communicating with evaluation app

- UART communication with BLE module

The regular version uses SCI12 (TXD12: PE1, RXD12: PE2) for UART communication, the small version uses SCI1 (TXD1: P26, RXD1: P30).

Table 7.2 lists UART settings.

Table 7.2 UART Settings

Setting	Value
Baudrate	250000 bps
Data length	8 bits
Parity	none
Stop bit	1 bit
Flow control	none

When `0xAA` is received from the BLE module, 8 bytes of data are transmitted, with the following values:

4th byte: X coordinate value

5th byte: Y coordinate value

6th byte: Z coordinate value

1st, 2nd, 3rd, 7th and 8th bytes: `0x00`

- USB communication with evaluation tool

Function SampleAplReceive(), which is called from the USB receive function in the CTSU API, has been added to the regular version.

Function SampleAplReceive(), which is called from the SC16 receive interrupt handler in the CTSU API, has been added to the small version.

Communication with the evaluation tool is conducted in the format shown in Figure 7.1

RX → PC																												
byte	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28
val	HEAD	ID	CMD	NOISE	GEST	X	Y	Z	TOP	BTM	RGT	LFT	TOP_R	BTM_R	RGT_R	LFT_R	END											
HEAD	Header																											
0x55	Constant value																											
ID	ID																											
unsigned char	Count up for each communication																											
CMD	Command																											
0x03	Result of measurement																											
NOISE	Result of noise environment																											
0	normal environment																											
1	noise environment																											
GEST	Result of gesture recognition																											
0	No detectiton																											
1	Right swipe																											
2	Left swipe																											
3	Front swipe																											
4	Back swipe																											
5	Push																											
6	Clockwise(slow)																											
7	Counter Clockwise(fast)																											
8	Reserve																											
9	Counter Clockwise(slow)																											
10	Counter Clockwise(fast)																											
11	Reserve																											
X, Y, Z	Result of 3D position calucuration																											
signed short	3D coordinate value																											
0x3FFF	No detectiton																											
TOP, BTM, RGT, LFT	Value of R_CAPPOS_GetAve																											
unsigned short	measurement value																											
TOP_R, BTM_R, RGT_R, LFT_R	Value of R_CAPPOS_GetRef																											
unsigned short	Reference value																											
END	Delimiter																											
0x0a	Constant value																											
PC → RX																												
byte	1	2	3	4																								
val	HEAD	ID	CMD	END																								
HEAD	Header																											
0x55	Constant value																											
ID	ID																											
unsigned char	Count up for each communication																											
CMD	Command																											
0x01	Start communication																											
0x02	Stop communication																											
END	Delimiter																											
0x0a	Constant value																											

Figure 7.1 Communication Format

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Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Jan 16, 2018	-	First edition issued
2.00	Fer 28, 2018	-	full-fledged revisions
2.10	Mar 30, 2018	14, 15, 16	Change the setting value of Table 5.5

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

- The characteristics of Microprocessing unit or Microcontroller unit products in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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